Challenges and Opportunities for Technion and the Israeli Chip Industry

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EE Department
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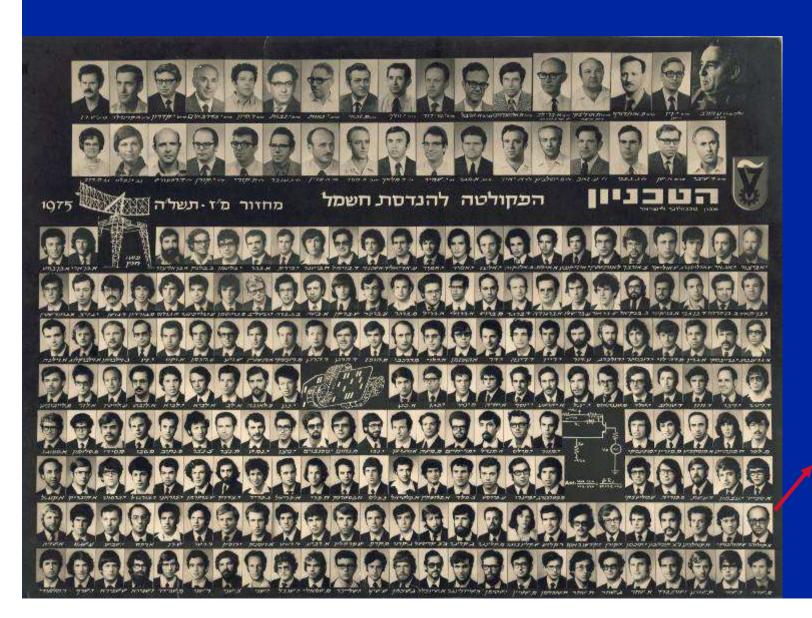


Evolution of an industry - Personal Viewpoint

Between Technion and Intel



1975: Graduated with EE





My First task at Intel

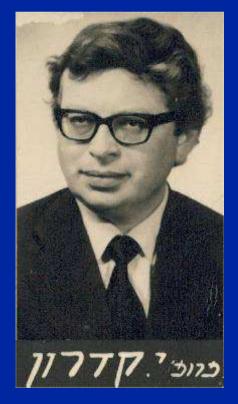
Ported simulator to Technion's big IBM computer



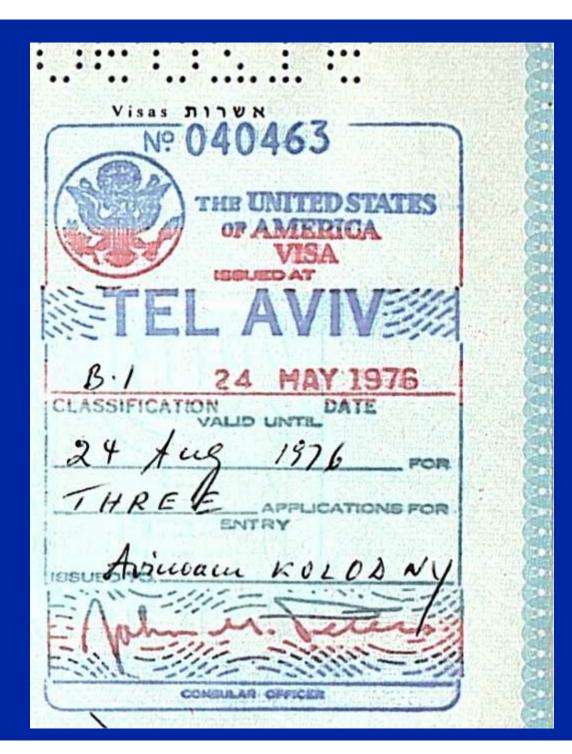


First trip to Intel Santa Clara

- Intel Israel acquired a minicomputer
- Needed a software person
- I was still a Technion graduate student...
- ... I asked my advisor...

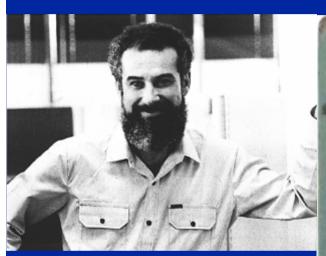




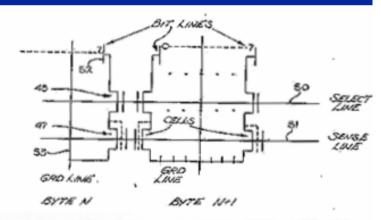




Post Doc at Intel's Non-Volatile Memory Group







HYBRID E² CELL AND RELATED ARRAY

Inventors: Boaz Eitan, Sunnyvale; Avi Kolodny,

Cupertino; Daniel Amrany, Supply James McCreary

Sunnyvale; James McCreary, Los

Gatos, all of Calif.

Assignee: 1

Intel Corporation, Santa Clara, Calif.



1980's: Intel moved from memories to processors

Design Automation for Processors

TABLE 1.	INTEL	PROCESSORS,	1971-1993.

PROCESSOR	INTRO DATE	PROCESS	TRANSISTORS	FREQUENCY
4004	1971	10 μm	2,300	108 KHz
8080	1974	6 μm	6,000	2 MHz
8086	1978	3 μm.	29,000	10 MHz
80286	1978 1982 RTL m	logellig Aballysis	134,000	12 MHz
80386	1982 RTL III 1985 Timing Cell lil	hraries	275,000	16 MHz
Intel 486 DX	1989 Logic	Synthesis	1.2 M	33 MHz
Pentium	1993	0.8 μm	3.1 M	60 MHz



Coping with the complexity

Intel's CAD History

SUMMER 2010 / IEEE SOLID-STATE CIRCUITS MAGAZINE

Patrick Gelsinger, Desmond Kirkpatrick, Avinoam Kolodny, and Gadi Singer

Such a CAD!

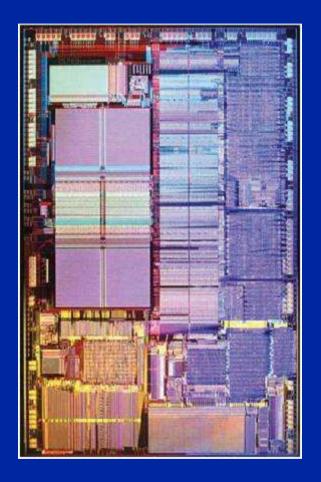
Coping with the complexity of microprocessor design at intel.



Synthesis-Based Chip Design

Logic designers
 became programmers

Israel became "Land of chips and software"



The 486 Processor

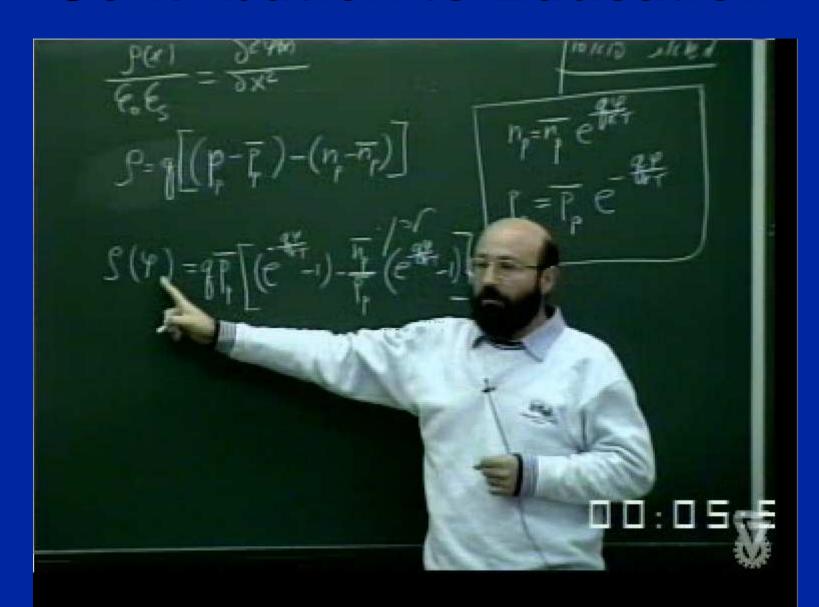


It was all implied by Moore's Law:

- From memories to processors to systems
- Digital revolution: changed the world

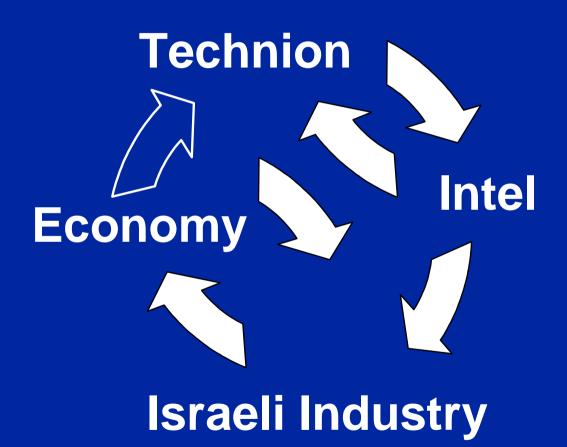


Contribution to Education



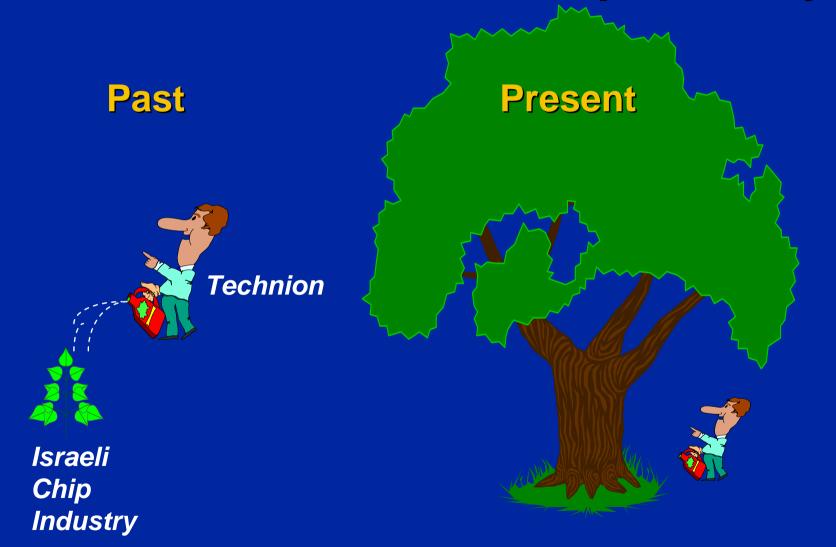


The Positive Spiral





Technion and the Israeli Chip Industry







Back to Technion

Avinoam Kolodny's Home Page



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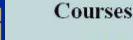
Research

Electronic Design Automation; Device, circuit and system modeling; Circuit design techniques; Engineering methodologies; Algorithms and software for analysis and synthesis of VLSI systems; VLSI architecture; VLSI interconnect; Networks on Chip.

Network-on-Chip

IEEE International NoC Symposium

MATRICS: Multiple AsymmeTRic Interconnected Core Systems





יסודות התקני מוליכים למחצה - מל"מ



<u>Current</u> Research Challenges

- Interconnect
- Energy efficiency
- Programming of 'many-core' systems



Interconnect and Complexity

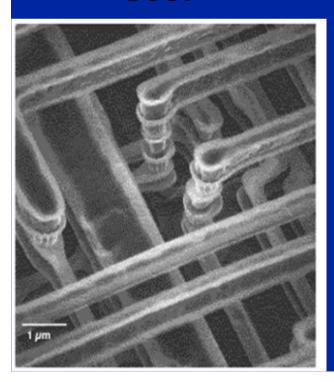


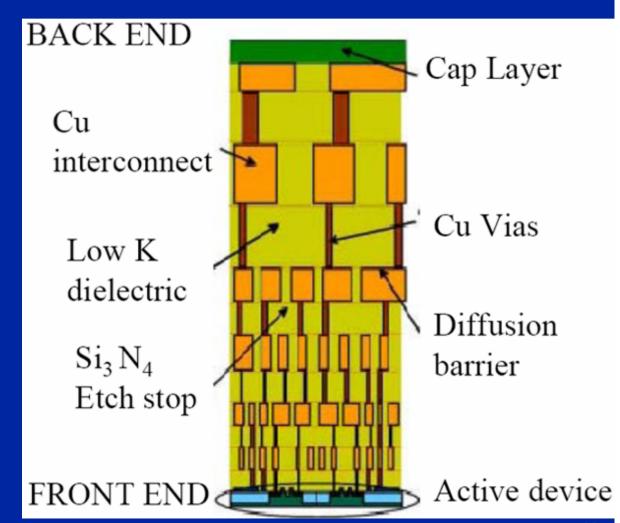


Adding metal Layers in Chips

Wires dominate:

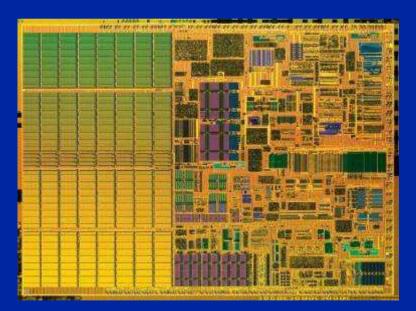
- Speed
- Power
- Noise
- Reliability
- -Cost



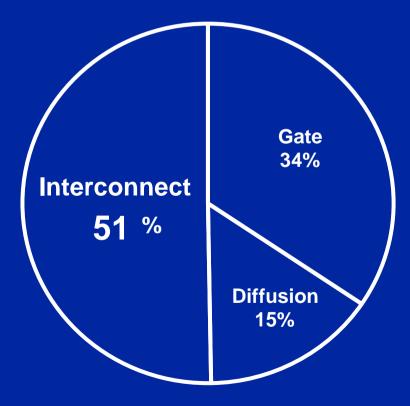


Interconnect Power: 2004 case study

- Intel's Pentium-M (designed in Haifa)
- Energy Consumption:
 - Bit-Transportation > computation !



* N. Magen, A. Kolodny, U. Weiser and N. Shamir, "Interconnect-Related Energy dissipation in a Low-Power Microprocessor", Proc. SLIP, 2004.





Bits as Cars on the Information highway



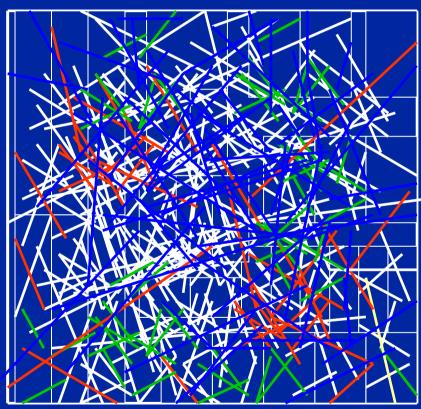
Energy efficiency in chip design

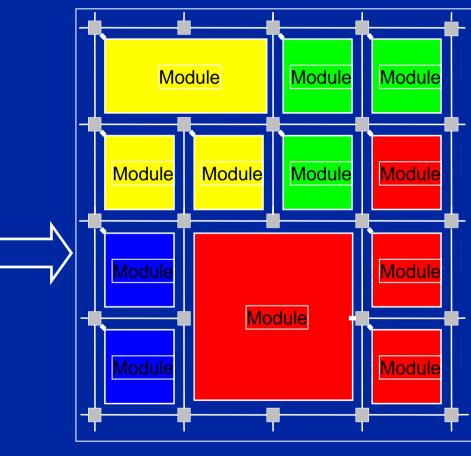


paradigm shift in VLSI: Network on Chip (NoC)

From: Dedicated signal wires

to: Shared network







* E. Bolotin, I. Cidon, R. Ginosar and A. Kolodny., "QNoC: QoS architecture and design process for Network on Chip", *JSA* special issue on NoC, 2004.



Network switch

_ Network link 24

Advanced Circuit Research Center





A Technion/Industry joint effort

Beyond 10 Years Ahead: Future Challenges and Opportunities

- MOS Device Scaling will slow down
 - New ways for system integration
 - Back to basic sciences
 - Interdisciplinary solutions
 - New architectures



Long Term Issues for the Industry

- Flat world
 - Competition with Asia
- Imperatives for Technion and the industry
 - Israel can win by innovation
 - Education: more Ph.D.'s
 - Need <u>stronger research collaboration</u>



Mythical Academia-Industry Mismatch

- Industry
 - Working results
 - Secret IP
 - Tight schedule
 - Low Risk
 - Control
 - Money

- Academia
 - Paper results
 - Publish
 - Slow
 - High risk
 - Freedom
 - Fame



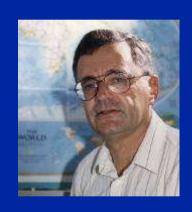
The Innovation Paradox - Applied Creativity in Organizations



Avi Kolodny (Technion)



Dadi Perlmutter (Intel)



Shlomo Maital (TIM)



* F. Chu, A. Kolodny, S. Maital and D. Perlmutter,

"The innovation paradox: Reconciling creativity & discipline – How winning organizations combine inspiration with perspiration," *Proceedings of IEEE International Engineering Management Conference*, October 2004.

"Head in the Clouds, Feet on the Ground"

 Let's apply this for academia-industry joint research!



Technion and the Industry -

Summary of Opportunities



1) Research Partnership

Technion enabled Israeli hi-tech Mostly as an <u>engineering school</u>



Industry will need <u>research</u> to innovate

- More Ph.D.'s
- Collaboration in research



2) Industry Funded Research

Technology driven by defense Government funded research



Economic developments lead Industry must fund academic research



3) Culture Transformation

Technion: theory and individual research

Industry: practical short term results



Joint research in computer engineering

- Long and short terms
- Teamwork



A Specific Plan: Computer Engineering Research Center







High Performance Computing



Create a focal point

The center as a focal point for collaboration Research in Israel, centered at the Technion, including Academia, R&D from Hi-Tech industry, as well as R&D from leading international companies (Microsoft, Intel, Google, etc.)

- The Technion gave invaluable leverage to
 - Israel
 - Israeli hi-tech industry
 - Individual Alumni

Let's work together for future success!



